

Title (en)  
METHOD AND DISPERSION FOR APPLYING A METAL LAYER TO A SUBSTRATE AND METALLIZABLE THERMOPLASTIC MOLDING COMPOUND

Title (de)  
VERFAHREN UND DISPERSION ZUM AUFBRINGEN EINER METALLSCHICHT AUF EINEM SUBSTRAT SOWIE METALLISIERBARE THERMOPLASTISCHE FORMMASSE

Title (fr)  
PROCÉDÉ ET DISPERSION POUR L'APPLICATION D'UNE COUCHE MÉTALLIQUE SUR UN SUBSTRAT, ET MATIÈRE THERMOPLASTIQUE POUR MOULAGE MÉTALLISABLE

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Application  
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Abstract (en)  
[origin: WO2009112573A2] The invention relates to a method for applying a metal layer to a substrate by deposition of a metal from a metallic salt solution, characterized in that the substrate surface comprises exfoliated graphite.

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